

## Fast Recovery Diodes (Hockey PUK Version), 920/1050 A



DO-200AB (B-PUK)

### FEATURES

- High power fast recovery diode series
- 2.0  $\mu$ s to 3.0  $\mu$ s recovery time
- High voltage ratings up to 3000 V
- High current capability
- Optimized turn-on and turn-off characteristics
- Low forward recovery
- Fast and soft reverse recovery
- Press PUK encapsulation
- Case style conform to JEDEC® DO-200AB (B-PUK)
- Maximum junction temperature 150 °C
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### PRODUCT SUMMARY

|                       |                  |
|-----------------------|------------------|
| $I_{F(AV)}$           | 920 A to 1050 A  |
| Package               | DO-200AB (B-PUK) |
| Circuit configuration | Single Diode     |

### TYPICAL APPLICATIONS

- Snubber diode for GTO
- High voltage freewheeling diode
- Fast recovery rectifier applications

### MAJOR RATINGS AND CHARACTERISTICS

| PARAMETER           | TEST CONDITIONS | SD1053C..L   |              | UNITS |
|---------------------|-----------------|--------------|--------------|-------|
|                     |                 | S20          | S30          |       |
| I <sub>F(AV)</sub>  |                 | 1050         | 920          | A     |
|                     | T <sub>hs</sub> | 55           | 55           | °C    |
| I <sub>F(RMS)</sub> |                 | 1940         | 1700         | A     |
| I <sub>FSM</sub>    | 50 Hz           | 15 000       | 13 000       |       |
|                     | 60 Hz           | 15 700       | 13 610       |       |
| V <sub>RRM</sub>    | Range           | 1800 to 2500 | 1800 to 3000 | V     |
| t <sub>rr</sub>     |                 | 2.0          | 3.0          | μs    |
|                     | T <sub>J</sub>  | 25           |              | °C    |
| T <sub>J</sub>      |                 | -40 to 150   |              |       |

### ELECTRICAL SPECIFICATIONS

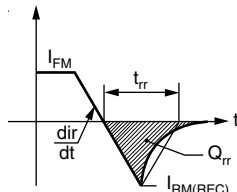
#### VOLTAGE RATINGS

| TYPE NUMBER      | VOLTAGE CODE | $V_{RRM}$ , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE<br>V | $V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE<br>V | $I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM<br>mA |
|------------------|--------------|----------------------------------------------------------|--------------------------------------------------------------|------------------------------------------------|
| VS-SD1053C..S20L | 18           | 1800                                                     | 1900                                                         | 50                                             |
|                  | 22           | 2200                                                     | 2300                                                         |                                                |
|                  | 25           | 2500                                                     | 2600                                                         |                                                |
| VS-SD1053C..S30L | 18           | 1800                                                     | 1900                                                         |                                                |
|                  | 22           | 2200                                                     | 2300                                                         |                                                |
|                  | 25           | 2500                                                     | 2600                                                         |                                                |
|                  | 28           | 2800                                                     | 2900                                                         |                                                |
|                  | 30           | 3000                                                     | 3100                                                         |                                                |

**FORWARD CONDUCTION**

| PARAMETER                                                     | SYMBOL        | TEST CONDITIONS                                                                         | SD1053C..L |           | UNITS              |
|---------------------------------------------------------------|---------------|-----------------------------------------------------------------------------------------|------------|-----------|--------------------|
|                                                               |               |                                                                                         | S20        | S30       |                    |
| Maximum average forward current at heatsink temperature       | $I_{F(AV)}$   | 180° conduction, half sine wave<br>Double side (single side) cooled                     | 1050 (450) | 920 (390) | A                  |
| Maximum RMS forward current                                   | $I_{F(RMS)}$  | 25 °C heatsink temperature double side cooled                                           | 55 (85)    | 55 (85)   | °C                 |
| Maximum peak, one-cycle forward, non-repetitive surge current | $I_{FSM}$     | t = 10 ms                                                                               | 1940       | 1700      | A                  |
|                                                               |               | No voltage reapplied                                                                    | 15 000     | 13 000    |                    |
|                                                               |               | t = 8.3 ms                                                                              | 15 700     | 13 610    |                    |
|                                                               |               | 100 % $V_{RRM}$ reapplied                                                               | 12 620     | 10 930    |                    |
| Maximum $I^2t$ for fusing                                     | $I^2t$        | t = 10 ms                                                                               | 13 210     | 11 450    | kA <sup>2</sup> s  |
|                                                               |               | No voltage reapplied                                                                    | 1125       | 845       |                    |
|                                                               |               | t = 8.3 ms                                                                              | 1027       | 772       |                    |
|                                                               |               | 100 % $V_{RRM}$ reapplied                                                               | 796        | 598       |                    |
| Maximum $I^2\sqrt{t}$ for fusing                              | $I^2\sqrt{t}$ | t = 0.1 to 10 ms, no voltage reapplied                                                  | 727        | 546       | kA <sup>2</sup> √s |
| Low level value of threshold voltage                          | $V_{F(TO)1}$  | (16.7 % $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$ , $T_J = T_J$ maximum) | 11 250     | 8450      | V                  |
| High level value of threshold voltage                         | $V_{F(TO)2}$  | ( $I > \pi \times I_{F(AV)}$ , $T_J = T_J$ maximum)                                     | 1.34       | 1.51      |                    |
| Low level value of forward slope resistance                   | $r_{f1}$      | (16.7 % $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$ , $T_J = T_J$ maximum) | 1.48       | 1.67      | mΩ                 |
| High level value of forward slope resistance                  | $r_{f2}$      | ( $I > \pi \times I_{F(AV)}$ , $T_J = T_J$ maximum)                                     | 0.37       | 0.50      |                    |
| Maximum forward voltage drop                                  | $V_{FM}$      | $I_{pk} = 1500$ A, $T_J = T_J$ maximum, $t_p = 10$ ms sinusoidal wave                   | 0.33       | 0.45      | V                  |

**RECOVERY CHARACTERISTICS**

| CODE | MAXIMUM VALUE AT $T_J = 25$ °C  | TEST CONDITIONS           |                |           | TYPICAL VALUES AT $T_J = 150$ °C |               |              |  |
|------|---------------------------------|---------------------------|----------------|-----------|----------------------------------|---------------|--------------|---------------------------------------------------------------------------------------|
|      | $t_{rr}$ AT 25 % $I_{RRM}$ (μs) | $I_{pk}$ SQUARE PULSE (A) | $di/dt$ (A/μs) | $V_r$ (V) | $t_{rr}$ AT 25 % $I_{RRM}$ (μs)  | $Q_{rr}$ (μC) | $I_{rr}$ (A) |                                                                                       |
| S20  | 2.0                             | 1000                      | 100            | - 50      | 4.0                              | 400           | 180          |                                                                                       |
| S30  | 3.0                             |                           |                |           | 4.5                              | 550           | 230          |                                                                                       |

**THERMAL AND MECHANICAL SPECIFICATIONS**

| PARAMETER                                                | SYMBOL         | TEST CONDITIONS                               | VALUES           | UNITS  |
|----------------------------------------------------------|----------------|-----------------------------------------------|------------------|--------|
| Maximum junction operating and storage temperature range | $T_J, T_{Stg}$ |                                               | -40 to 150       | °C     |
| Maximum thermal resistance, case junction to heatsink    | $R_{thJ-hs}$   | DC operation single side cooled               | 0.073            | K/W    |
|                                                          |                | DC operation double side cooled               | 0.031            |        |
| Mounting force, ± 10 %                                   |                |                                               | 14 700 (1500)    | N (kg) |
| Approximate weight                                       |                |                                               | 255              | g      |
| Case style                                               |                | See dimensions - link at the end of datasheet | DO-200AB (B-PUK) |        |

 **$\Delta R_{thJ-hs}$  CONDUCTION**

| CONDUCTION ANGLE | SINUSOIDAL CONDUCTION |             | RECTANGULAR CONDUCTION |             | TEST CONDITIONS     | UNITS |
|------------------|-----------------------|-------------|------------------------|-------------|---------------------|-------|
|                  | SINGLE SIDE           | DOUBLE SIDE | SINGLE SIDE            | DOUBLE SIDE |                     |       |
| 180°             | 0.009                 | 0.008       | 0.006                  | 0.006       | $T_J = T_J$ maximum | K/W   |
| 120°             | 0.011                 | 0.011       | 0.011                  | 0.011       |                     |       |
| 90°              | 0.014                 | 0.014       | 0.015                  | 0.015       |                     |       |
| 60°              | 0.020                 | 0.021       | 0.021                  | 0.022       |                     |       |
| 30°              | 0.036                 | 0.036       | 0.036                  | 0.036       |                     |       |

**Note**

- The table above shows the increment of thermal resistance  $R_{thJ-hs}$  when devices operate at different conduction angles than DC

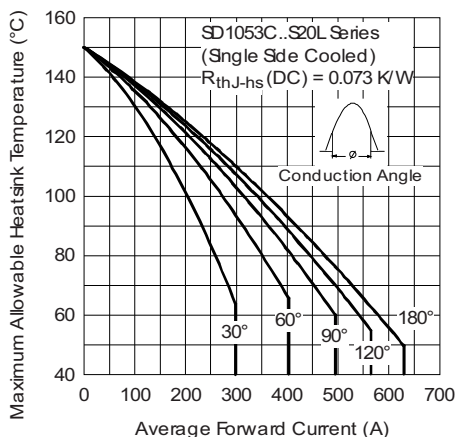


Fig. 1 - Current Ratings Characteristics

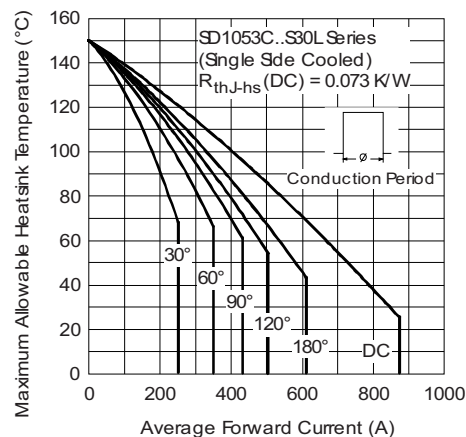


Fig. 4 - Current Ratings Characteristics

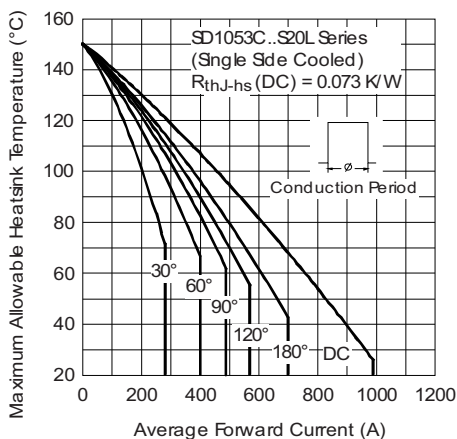


Fig. 2 - Current Ratings Characteristics

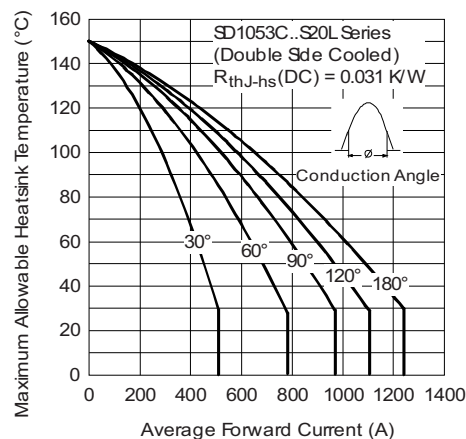


Fig. 5 - Current Ratings Characteristics

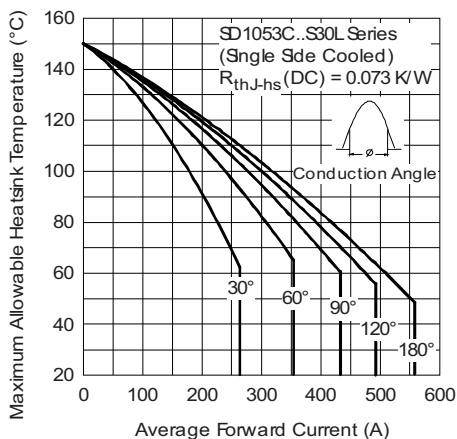


Fig. 3 - Current Ratings Characteristics

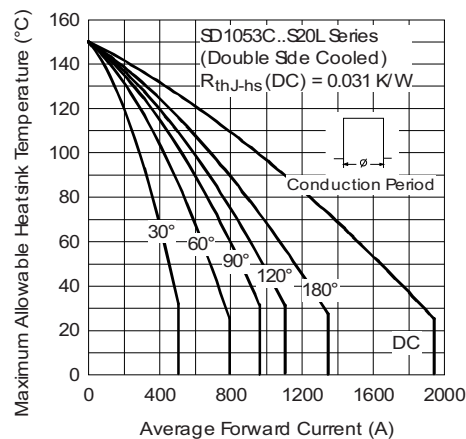


Fig. 6 - Current Ratings Characteristics

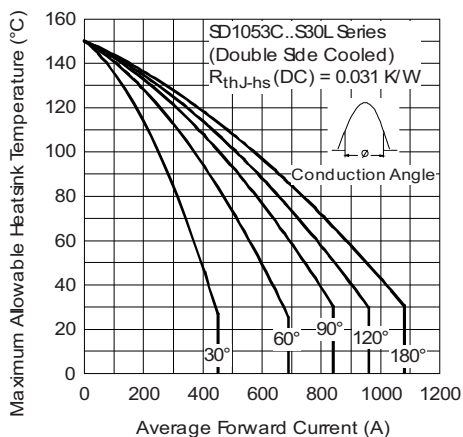


Fig. 7 - Current Ratings Characteristics

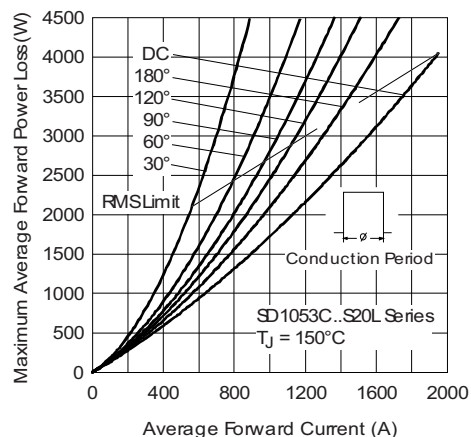


Fig. 10 - Forward Power Loss Characteristics

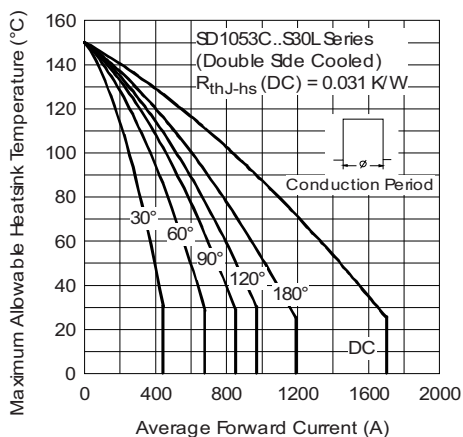


Fig. 8 - Current Ratings Characteristics

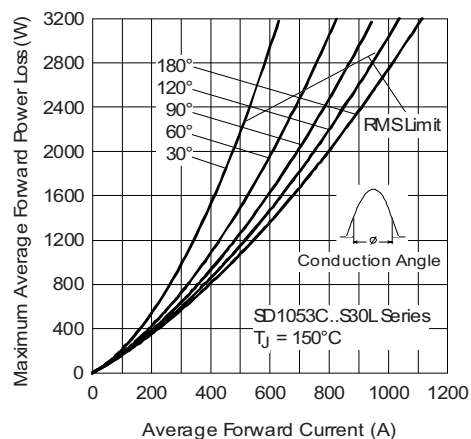


Fig. 11 - Forward Power Loss Characteristics

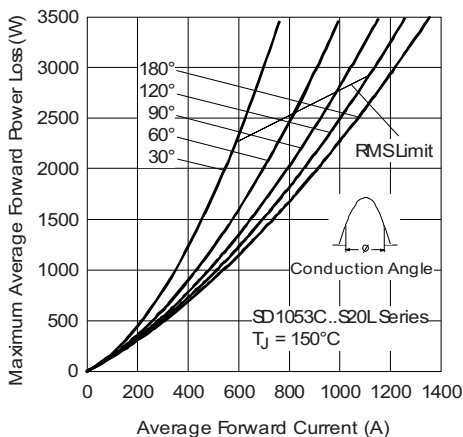


Fig. 9 - Forward Power Loss Characteristics

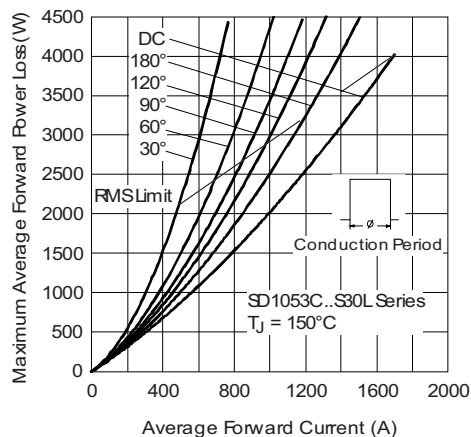


Fig. 12 - Forward Power Loss Characteristics

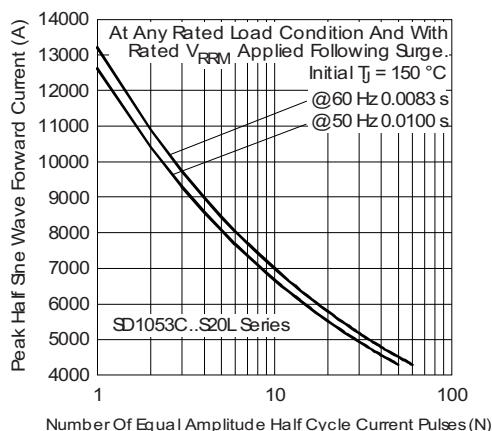


Fig. 13 - Maximum Non-Repetitive Surge Current

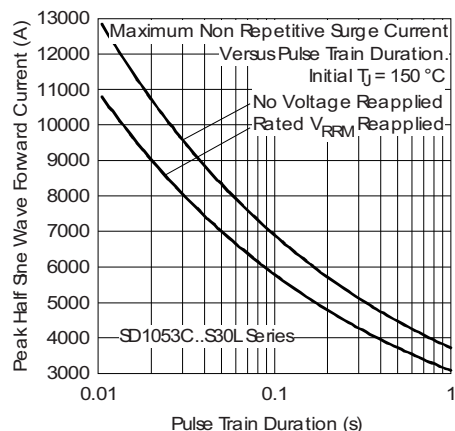


Fig. 16 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

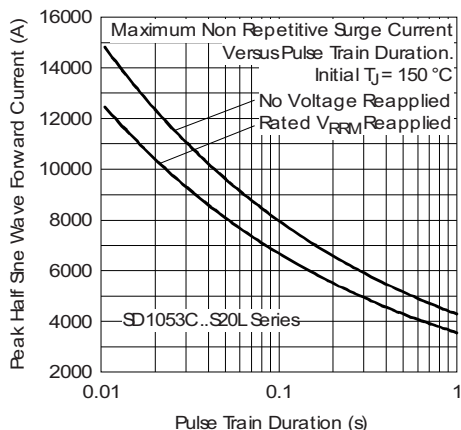


Fig. 14 - Maximum Non-Repetitive Surge Current

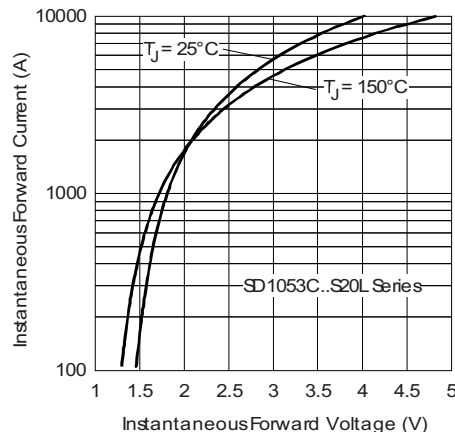


Fig. 17 - Forward Voltage Drop Characteristics

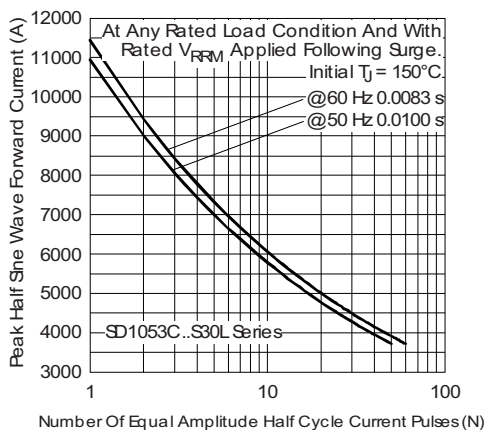


Fig. 15 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

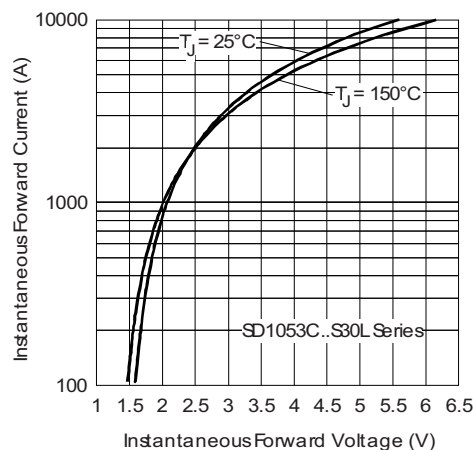


Fig. 18 - Forward Voltage Drop Characteristics

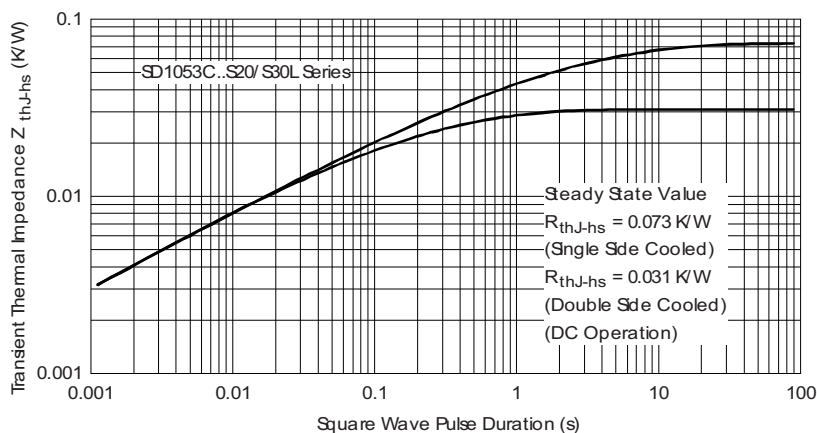
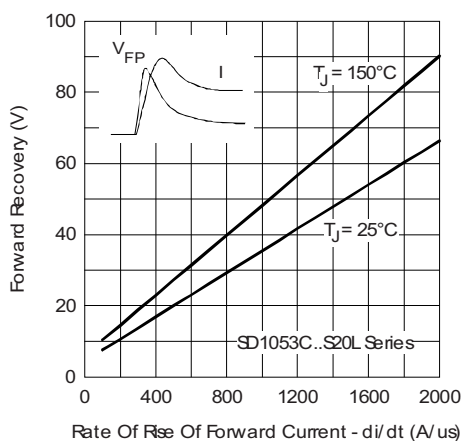

Fig. 19 - Thermal Impedance  $Z_{thJ-hs}$  Characteristic


Fig. 20 - Typical Forward Recovery Characteristics

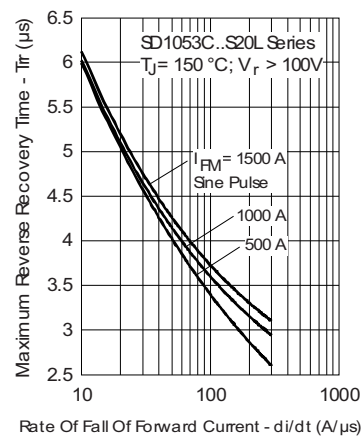


Fig. 22 - Recovery Time Characteristics

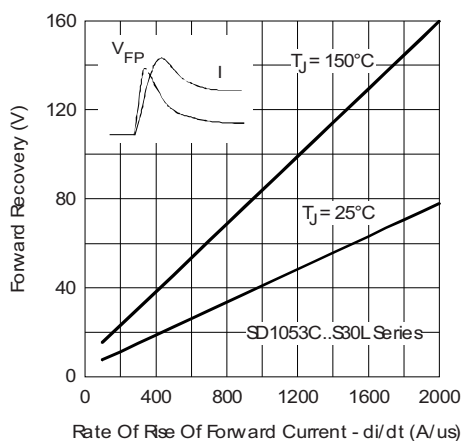


Fig. 21 - Typical Forward Recovery Characteristics

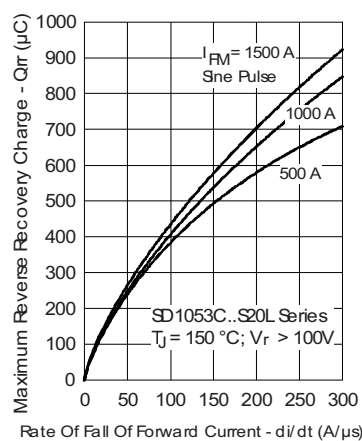


Fig. 23 - Recovery Charge Characteristics

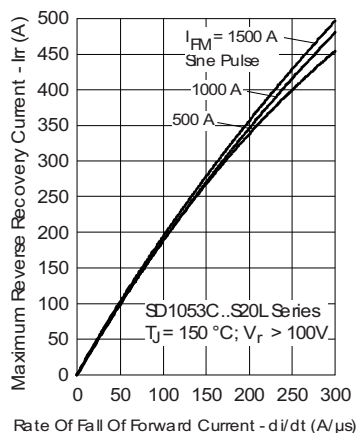


Fig. 24 - Recovery Current Characteristics

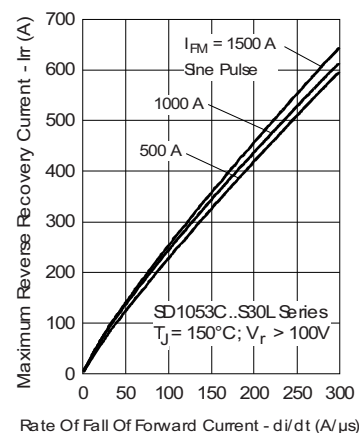


Fig. 27 - Recovery Current Characteristics

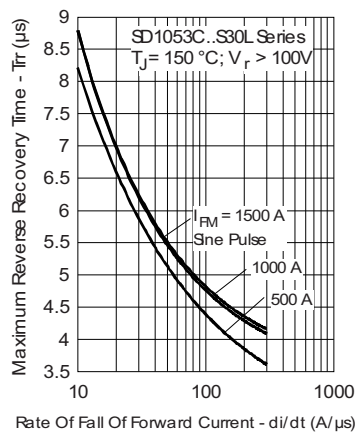


Fig. 25 - Recovery Time Characteristics

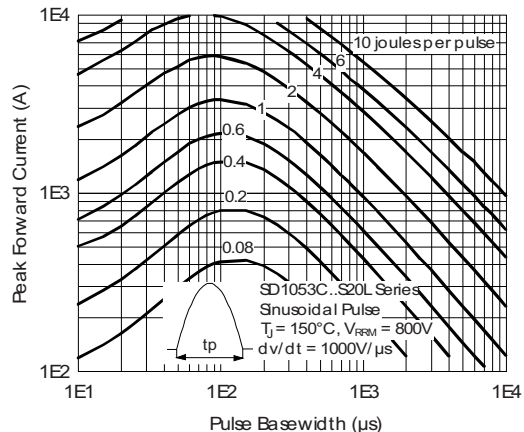


Fig. 28 - Maximum Total Energy Loss Per Pulse Characteristics

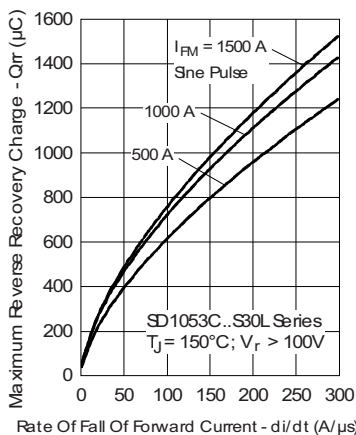


Fig. 26 - Recovery Charge Characteristics

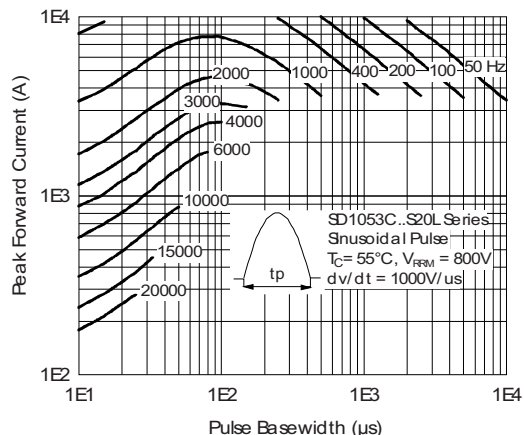


Fig. 29 - Frequency Characteristics

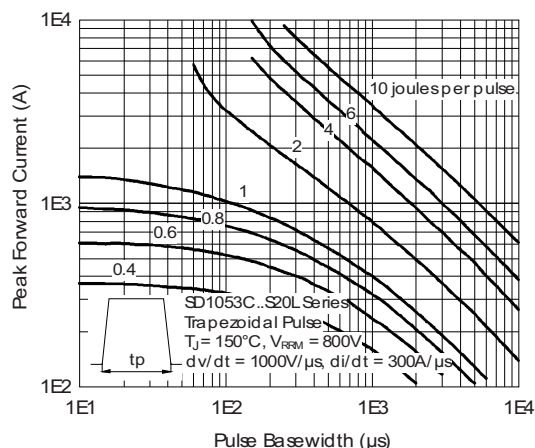


Fig. 30 - Maximum Total Energy Loss Per Pulse Characteristics

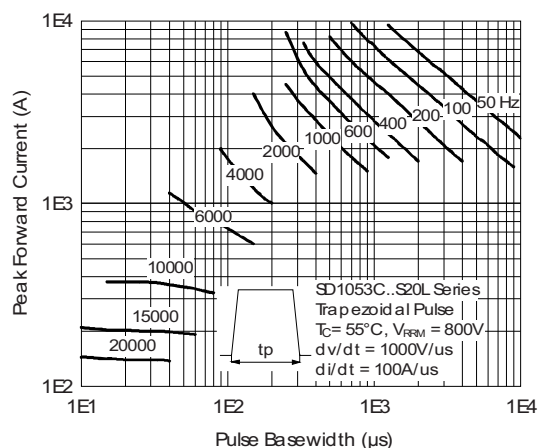


Fig. 33 - Frequency Characteristics

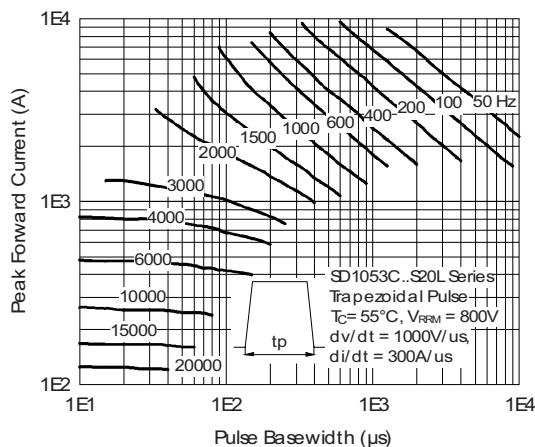


Fig. 31 - Frequency Characteristics

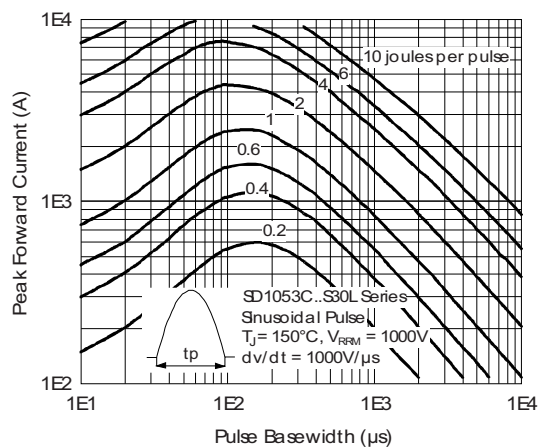


Fig. 34 - Maximum Total Energy Loss Per Pulse Characteristics

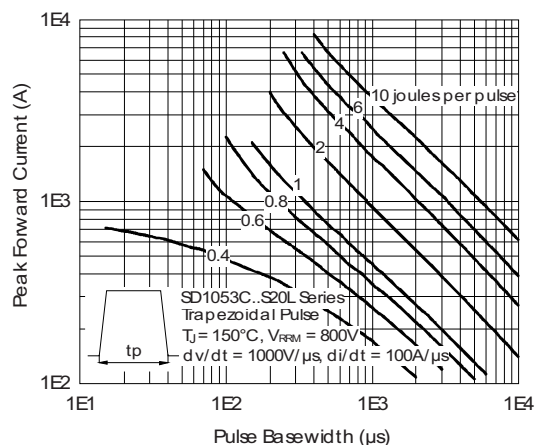


Fig. 32 - Maximum Total Energy Loss Per Pulse Characteristics

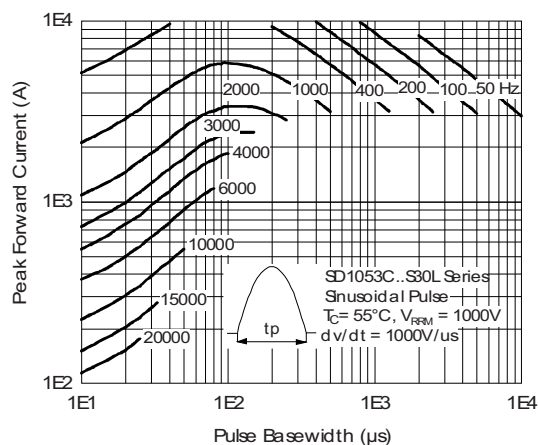


Fig. 35 - Frequency Characteristics

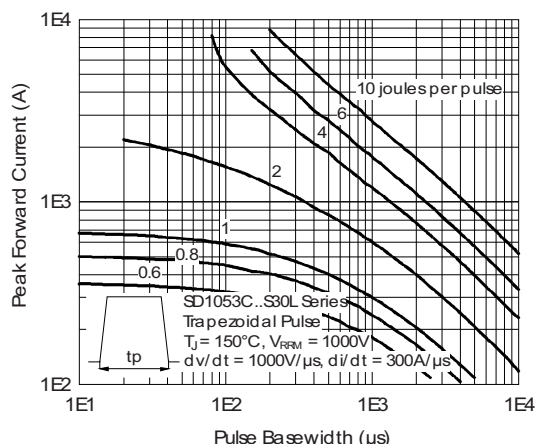


Fig. 36 - Maximum Total Energy Loss Per Pulse Characteristics

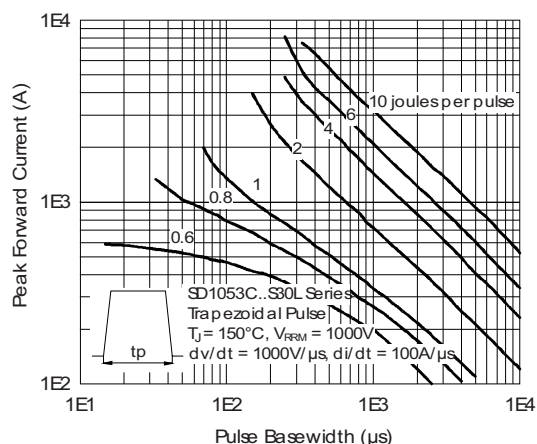


Fig. 38 - Maximum Total Energy Loss Per Pulse Characteristics

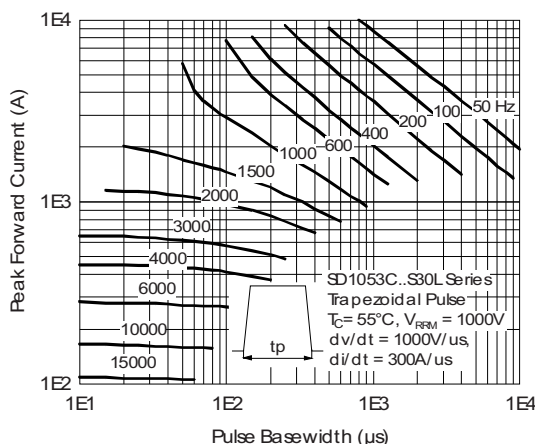


Fig. 37 - Frequency Characteristics

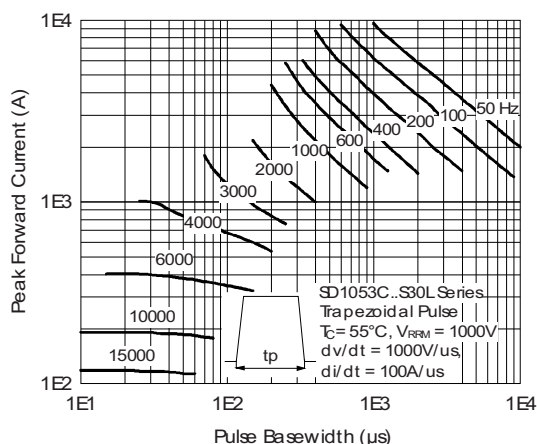


Fig. 39 - Frequency Characteristics

### ORDERING INFORMATION TABLE

| Device code | VS-                                                        | SD | 105 | 3 | C | 30 | S30 | L |
|-------------|------------------------------------------------------------|----|-----|---|---|----|-----|---|
|             | 1                                                          | 2  | 3   | 4 | 5 | 6  | 7   | 8 |
| 1           | Vishay Semiconductors product                              |    |     |   |   |    |     |   |
| 2           | Diode                                                      |    |     |   |   |    |     |   |
| 3           | Essential part number                                      |    |     |   |   |    |     |   |
| 4           | 3 = Fast recovery                                          |    |     |   |   |    |     |   |
| 5           | C = Ceramic PUK                                            |    |     |   |   |    |     |   |
| 6           | Voltage code x 100 = $V_{RRM}$ (see Voltage Ratings table) |    |     |   |   |    |     |   |
| 7           | $t_{rr}$ code                                              |    |     |   |   |    |     |   |
| 8           | L = PUK case DO-200AB (B-PUK)                              |    |     |   |   |    |     |   |

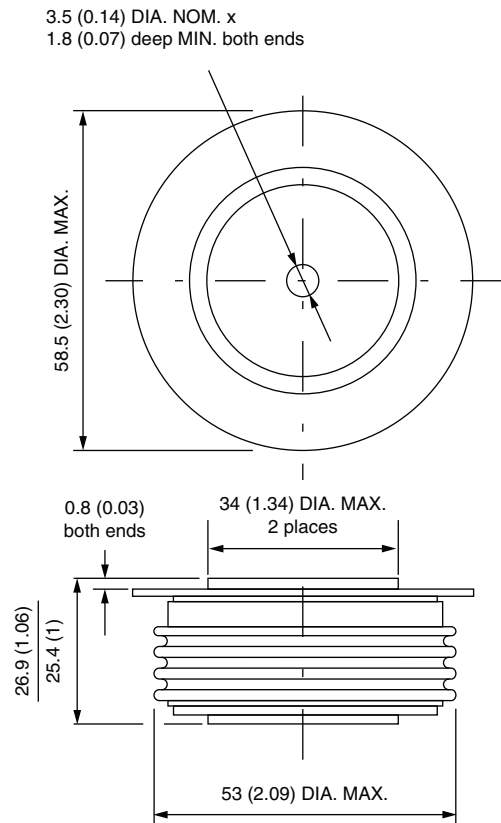
### LINKS TO RELATED DOCUMENTS

Dimensions

[www.vishay.com/doc?95246](http://www.vishay.com/doc?95246)

## DO-200AB (B-PUK)

**DIMENSIONS** in millimeters (inches)



Quote between upper and lower pole pieces has to be considered after application of mounting force (see Thermal and Mechanical Specifications)



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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**

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- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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